



US00D353818S

# United States Patent [19] Nakamura

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[45] Date of Patent: **\*\* Dec. 27, 1994**

[54] HEADPHONE

[75] Inventor: **Mitsuhiro Nakamura, Tokyo, Japan**

[73] Assignee: **Sony Corporation, Tokyo, Japan**

[\*\*] Term: **14 Years**

[21] Appl. No.: **16,126**

[22] Filed: **Dec. 8, 1993**

[52] U.S. Cl. .... **D14/205**

[58] Field of Search ..... **D14/205; 381/183, 187; 379/430, 444**

[56] **References Cited**

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3,810,525 5/1974 Crenna ..... 381/183

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Stereo Review; Dec. 1987; Headphone (top of page).  
Crutchfield; Summer 1986; p. 89; Headphone I.

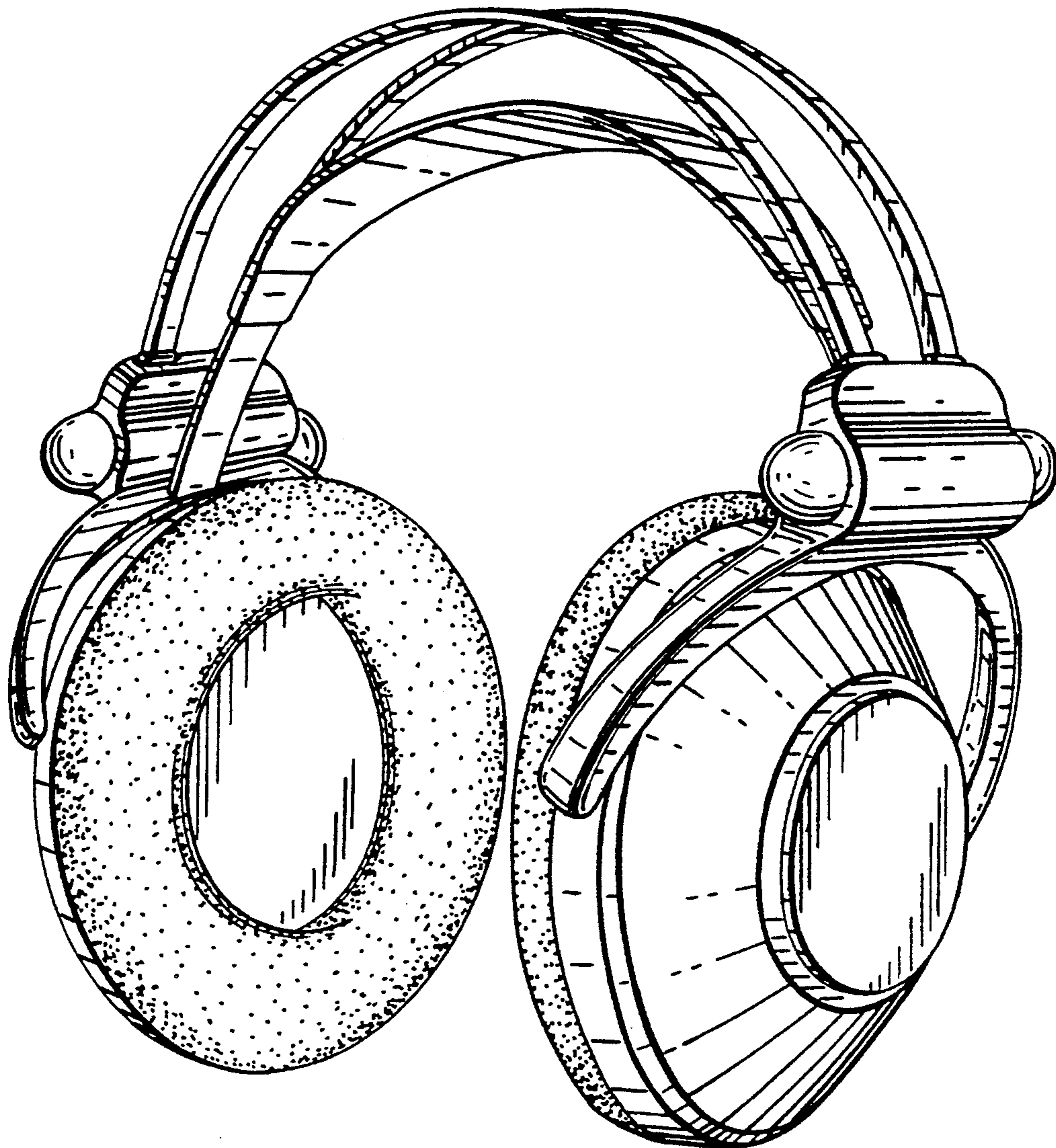
*Primary Examiner*—B. J. Bullock  
*Attorney, Agent, or Firm*—Jay H. Maioli

[57] **CLAIM**

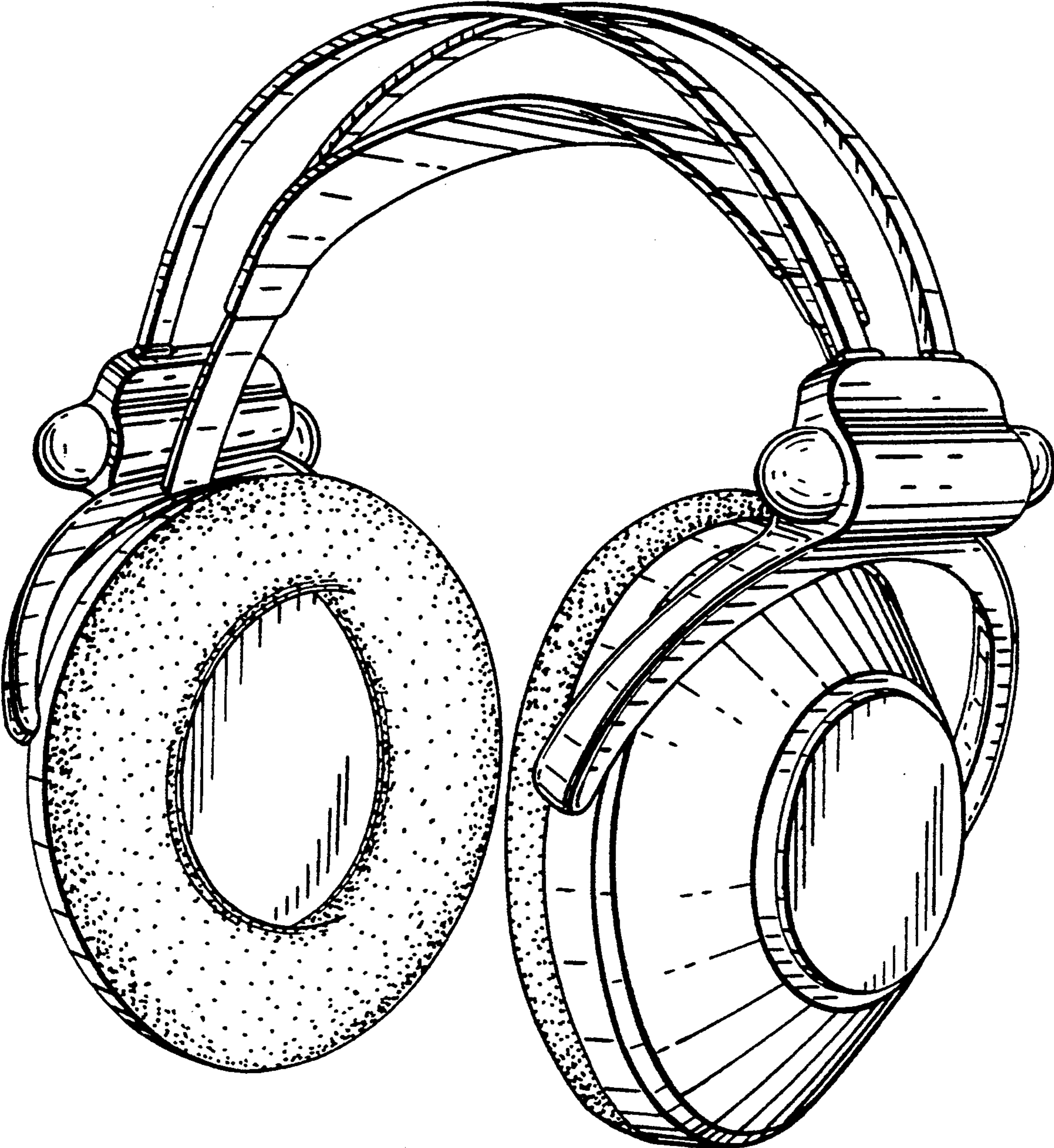
The ornamental design for a headphone, as shown and described.

**DESCRIPTION**

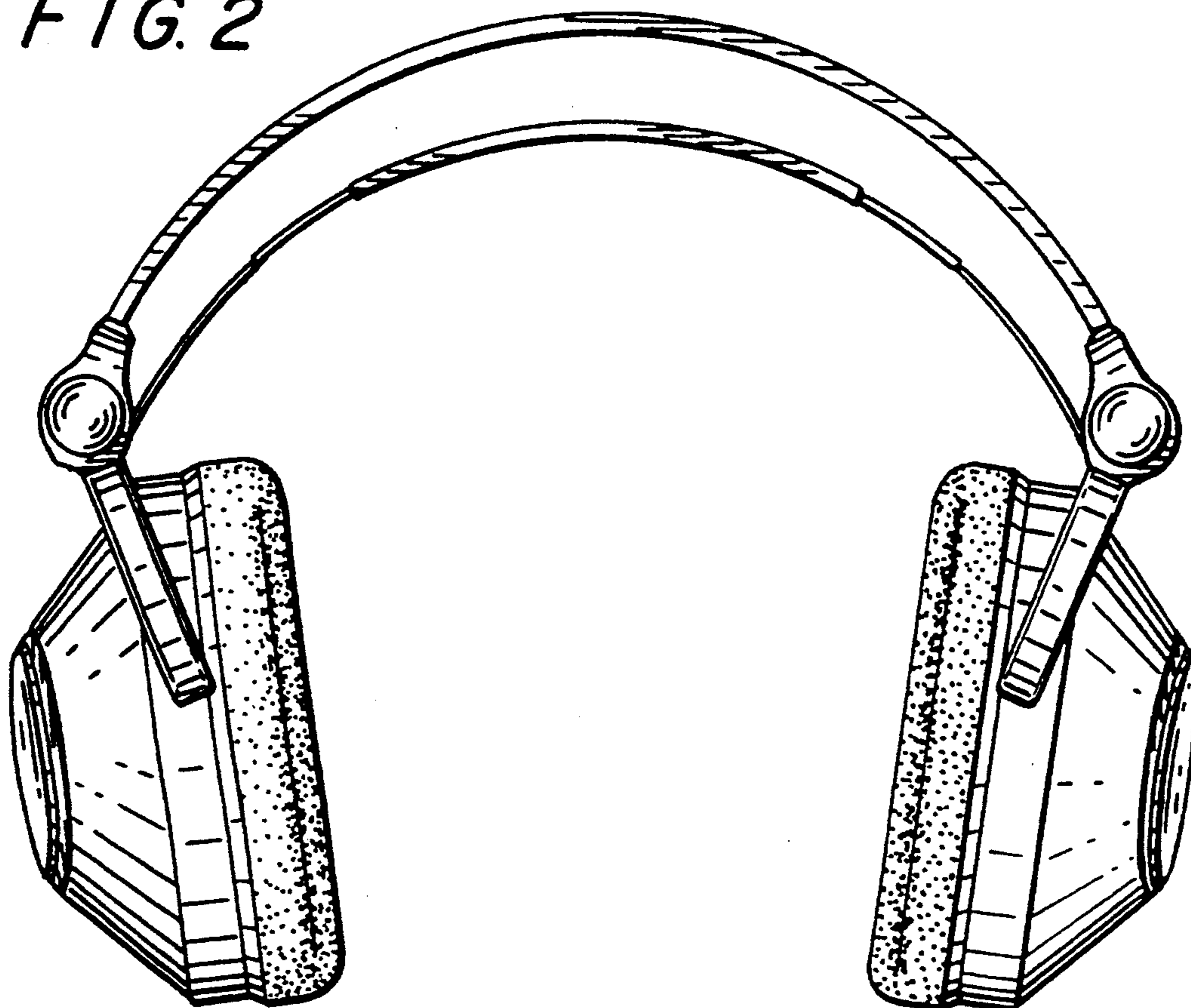
FIG. 1 is a top, front and right-side perspective view of a headphone, showing my new design;  
FIG. 2 is a reduced front elevational view thereof;  
FIG. 3 is a reduced rear elevational view thereof;  
FIG. 4 is a reduced left side elevational view thereof;  
FIG. 5 is a reduced right side elevational view thereof;  
FIG. 6 is a reduced top plan view thereof; and,  
FIG. 7 is a reduced bottom plan view thereof.



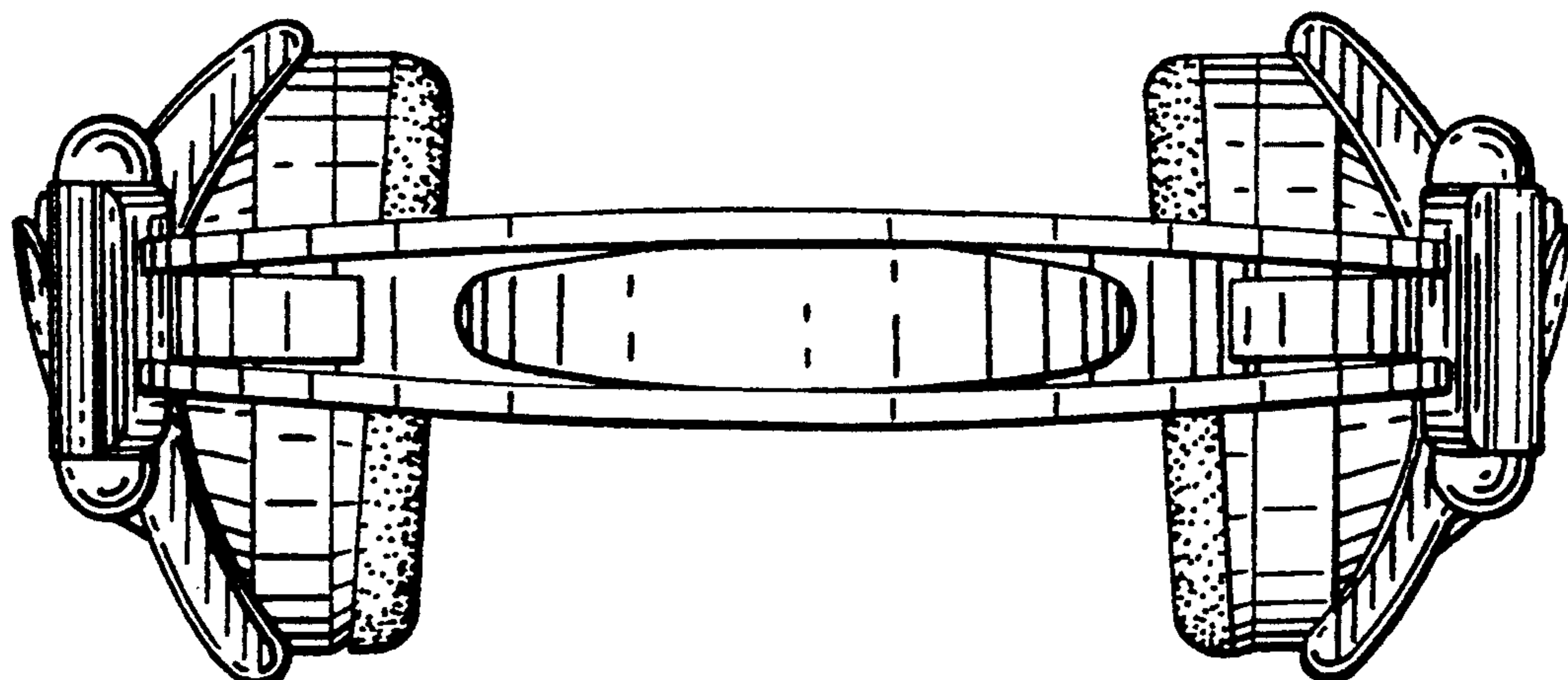
*FIG. 1*



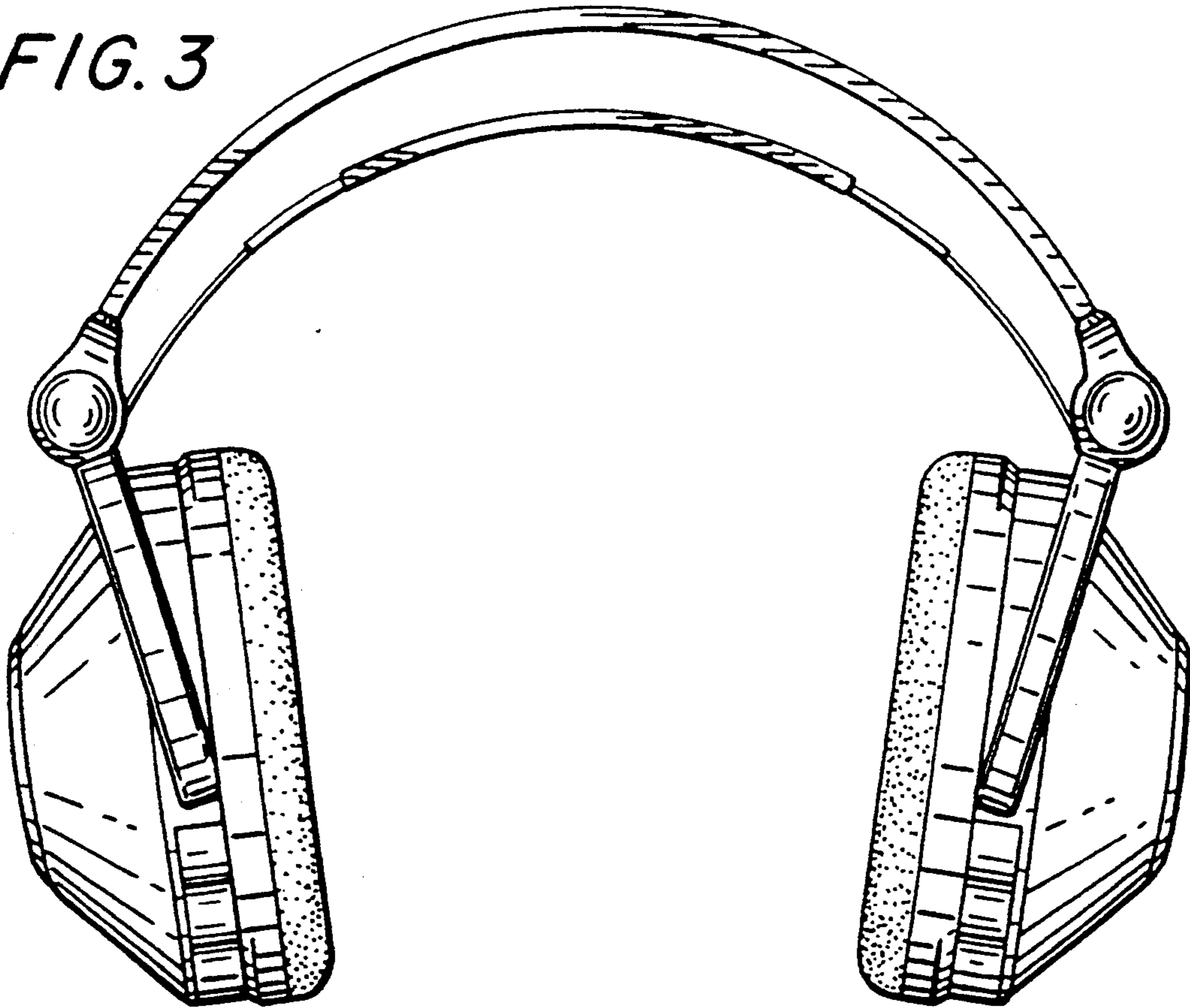
*FIG. 2*



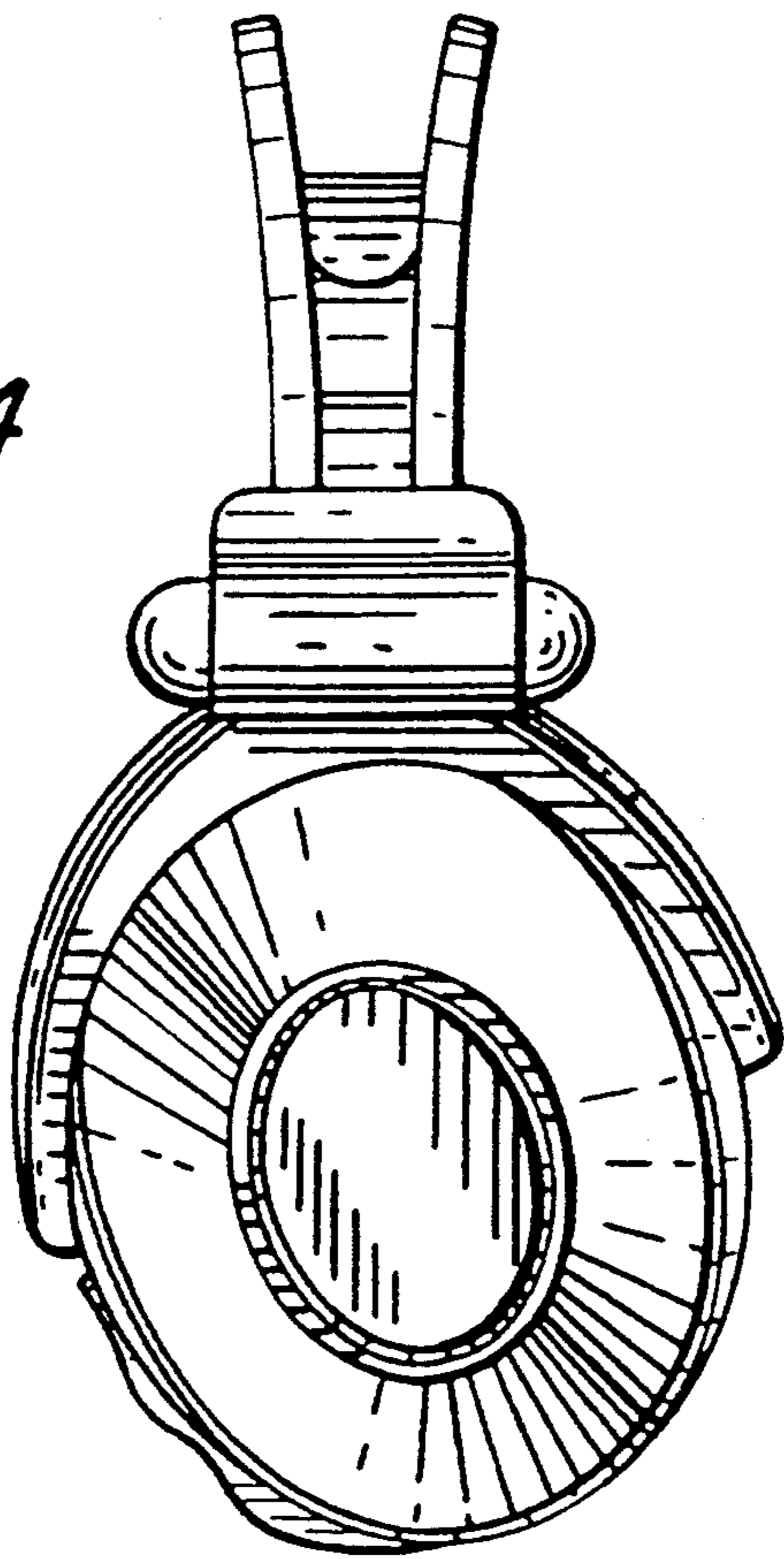
*FIG. 6*



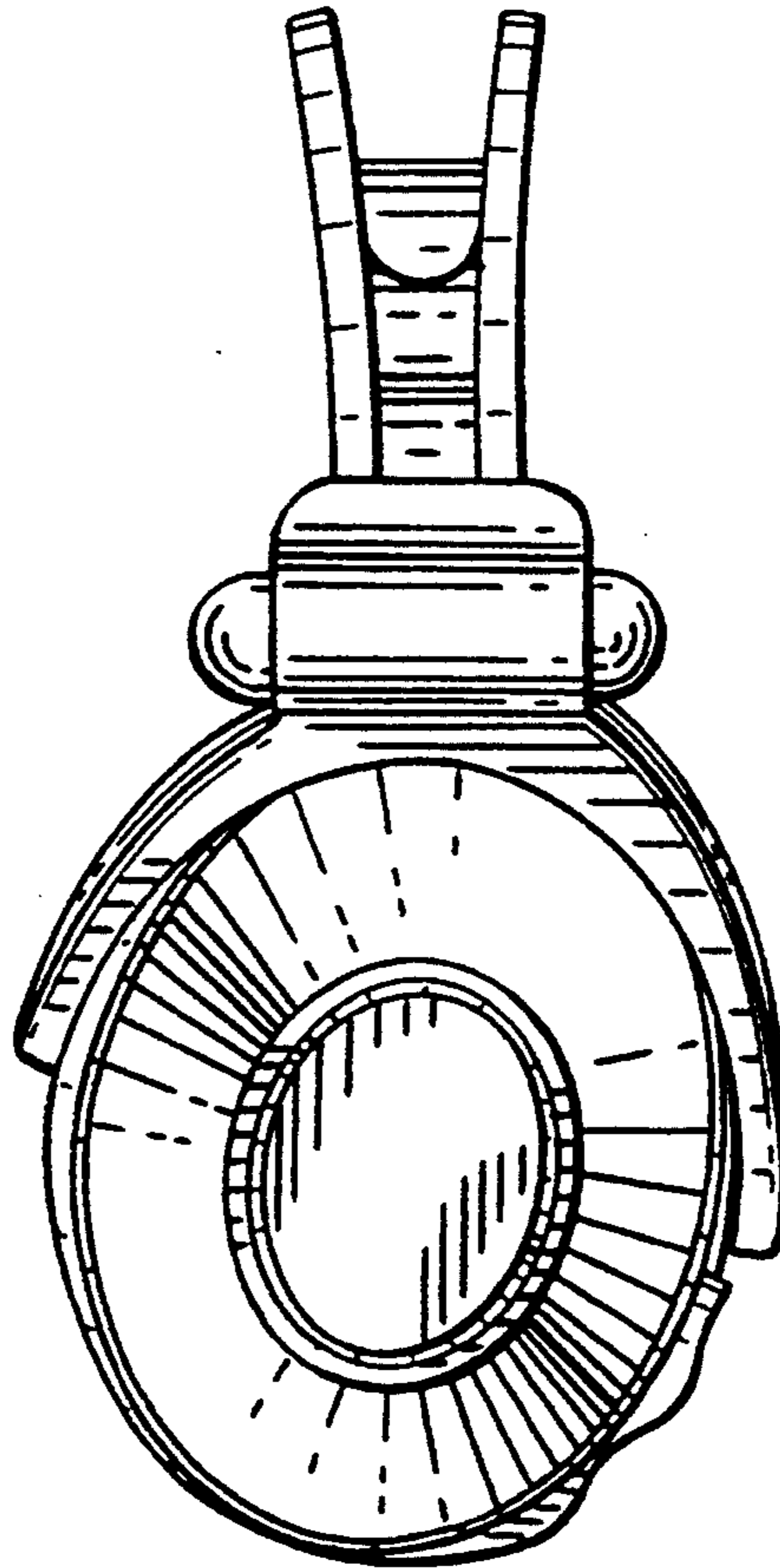
*FIG. 3*



*FIG. 4*



*FIG. 5*



*FIG. 7*

